

A close-up, dark green background of a printed circuit board (PCB) with intricate white and gold traces and pads.

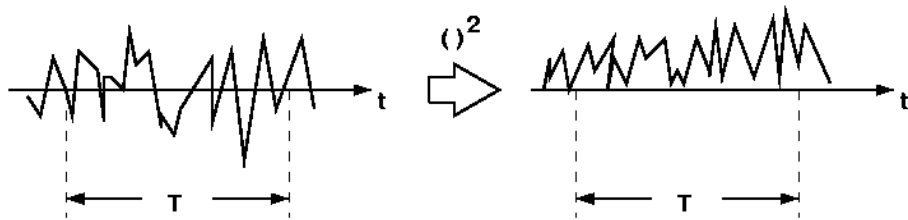
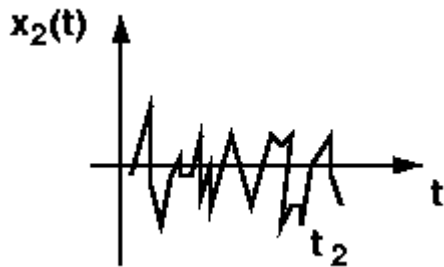
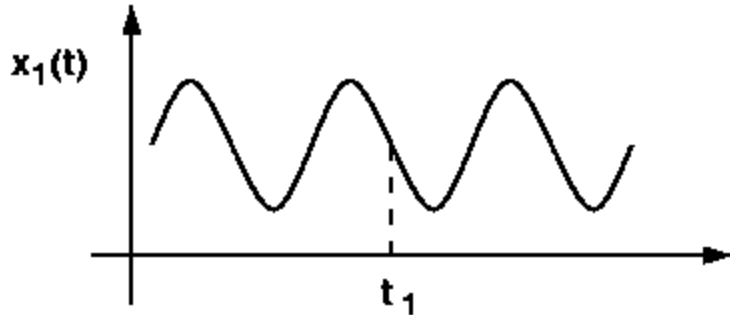
# CHAPTER 7

# Noise

# Outline

- 1. Statistical Characteristics of Noise**
2. Types of Noise
3. Representation of Noise in Circuits
4. Noise in Single-Stage Amplifiers
5. Noise in Differential Pairs

# Statistical Behavior of Noise



- Noise is a random process.
  - The value of noise can not be predicted at any time even if the past values are known.
  - Observe the noise for a long time and using the measured results to construct a “statistical model”.
  - In many cases, the average power of noise is predictable.

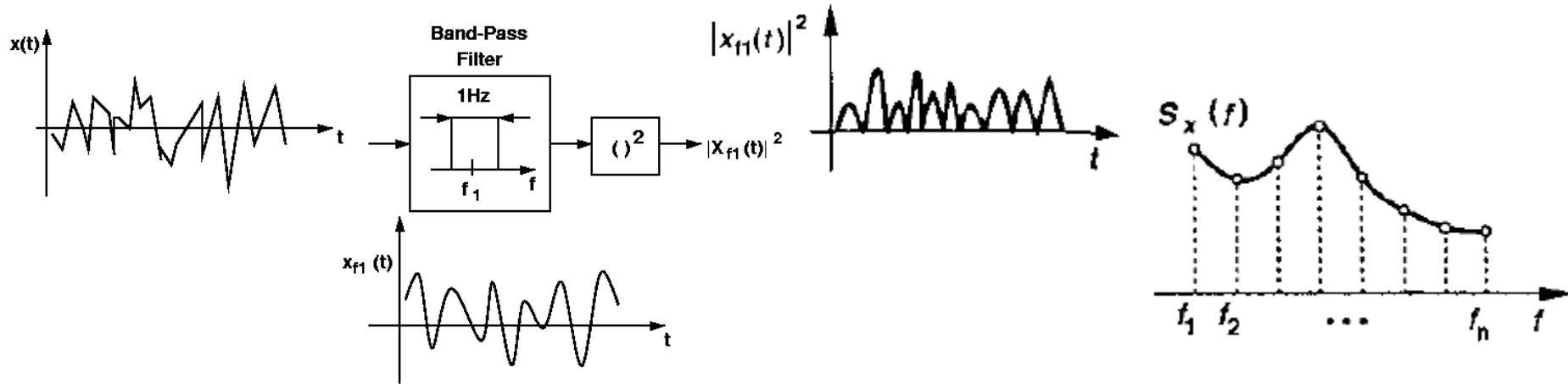
$$P_{av} = \lim_{T \rightarrow \infty} \frac{1}{T} \int_{-T/2}^{T/2} \frac{v^2(t)}{R_L} dt = \lim_{T \rightarrow \infty} \frac{1}{T} \int_{-T/2}^{T/2} x^2(t) dt$$

unit : (V<sup>2</sup>) in stead of (W)

Normalize the area under waveform to T

# Noise Spectrum

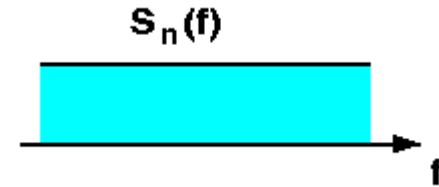
- The concept of noise power becomes more versatile if defined with regard to the *frequency content of noise* – *Power spectral density (PSD)*



- The PSD,  $S_x(f)$ , of a noise waveform  $x(t)$  is defined as the average power carried by  $x(t)$  in a one-Hertz bandwidth around  $f$ , expressed in  $V^2/Hz$ .
- The square root of  $S_x(f)$  expressed in  $V / \sqrt{Hz}$ .
- Input noise =  $3n V / \sqrt{Hz}$  at 100Mhz means average power in a 1Hz bandwidth at 100Mhz =  $(3e-9)^2 V^2$ .

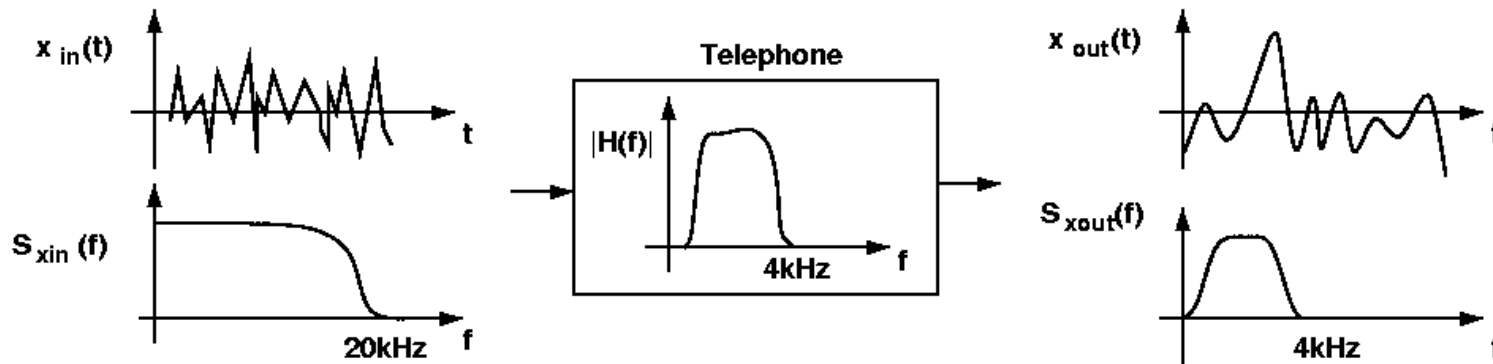
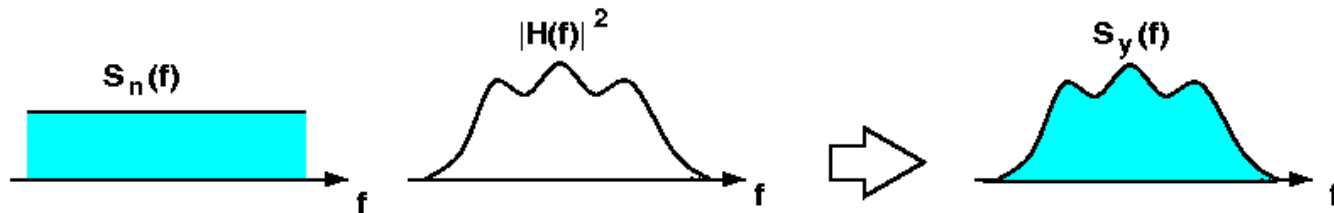
# Spectral Shaping

- White noise – the PSD displays the same value at all frequencies.



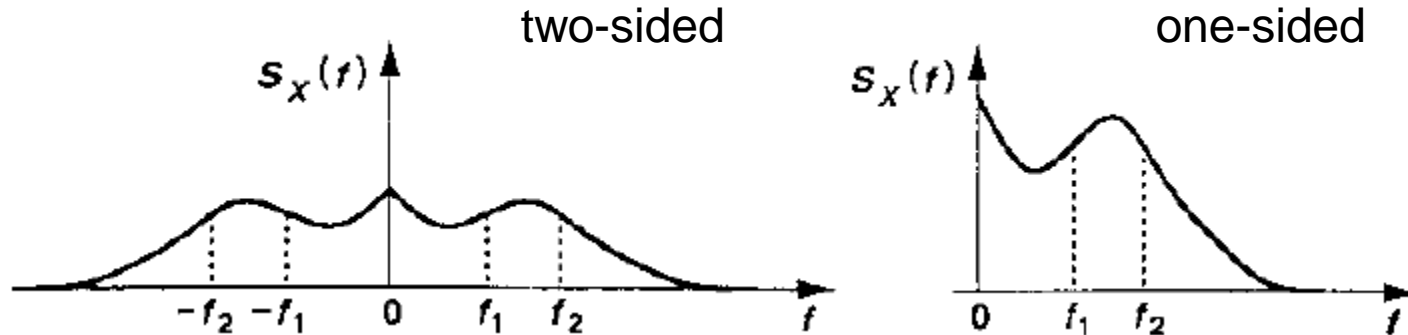
- If a signal with spectrum  $S_x(f)$  is applied to a linear time-invariant system with transfer function  $H(s)$ , then the output spectrum is given by

$$S_Y(f) = S_X(f) |H(f)|^2 \quad \text{where} \quad H(f) = H(s = j2\pi f)$$

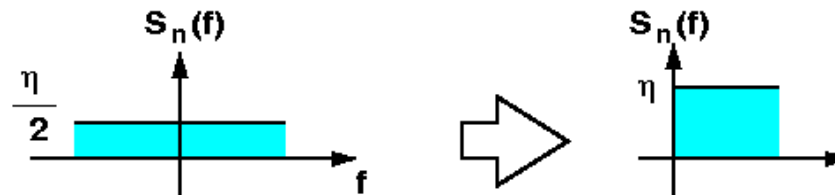


# Noise Spectra

- Since  $S_x(f)$  is an even function of  $f$  for real  $x(t)$ .



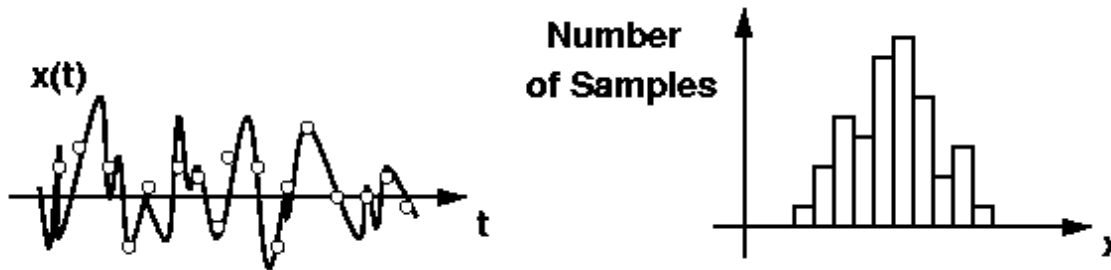
- The negative frequency part of the spectrum is folded around the vertical axis and added to the positive frequency part.



$$P_{f_1, f_2} = \int_{-f_2}^{-f_1} S_X(f) df + \int_{f_1}^{f_2} S_X(f) df = 2 \int_{f_1}^{f_2} S_X(f) df$$

# Amplitude Distribution

- Distribution of amplitude – *Probability density function (PDF)*.
- The distribution of  $x(t)$  is defined as
  - $p_x(x)dx = \text{probability of } x < X < x + dx$ ,  $X$  is the measured value of  $x(t)$



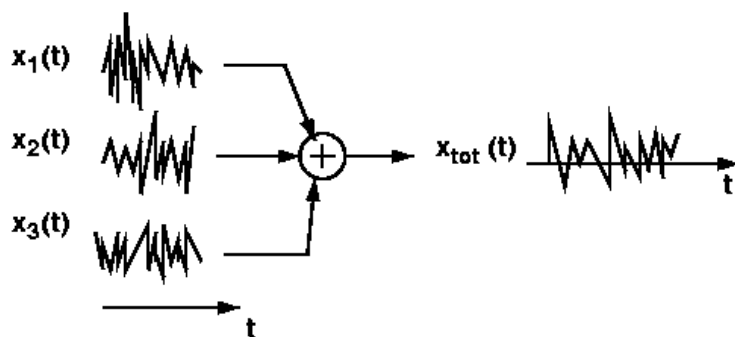
- *Gaussian (Normal) Distribution*
  - The *central limit theorem* states that if many independent random process with arbitrary PDFs are added, the PDF of the sum approaches a *Gaussian distribution*.
  - The *Gaussian PDF is defined as* 
$$p_x(f) = \frac{1}{\sigma\sqrt{2\pi}} \exp \frac{-(x-m)^2}{2\sigma^2}$$

# Correlated and Uncorrelated Sources

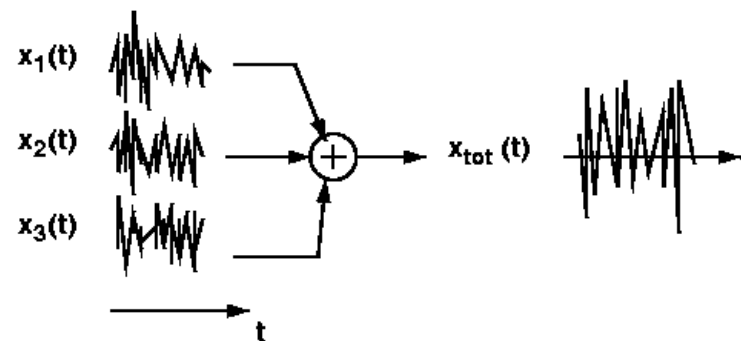
- For deterministic voltages and currents, use the superposition principle.
- In noise analysis, the average noise power is of interest.

$$\begin{aligned} P_{av} &= \lim_{T \rightarrow \infty} \frac{1}{T} \int_{-T/2}^{T/2} [x_1(t) + x_2(t)]^2 dt \\ &= \lim_{T \rightarrow \infty} \frac{1}{T} \int_{-T/2}^{T/2} x_1^2(t) dt + \lim_{T \rightarrow \infty} \frac{1}{T} \int_{-T/2}^{T/2} x_2^2(t) dt + \lim_{T \rightarrow \infty} \frac{1}{T} \int_{-T/2}^{T/2} 2x_1(t)x_2(t) dt \\ &= P_{av1} + P_{av2} + \lim_{T \rightarrow \infty} \frac{1}{T} \int_{-T/2}^{T/2} 2x_1(t)x_2(t) dt \end{aligned}$$

- $P_{av1}$  and  $P_{av2}$  denote the average power of  $x_1(t)$  and  $x_2(t)$ .
- The third term is the “**correlation**” between  $x_1(t)$  and  $x_2(t)$ .
- If generated by independent devices, the correlation = 0.



uncorrelated noise



correlated noise



# Outline

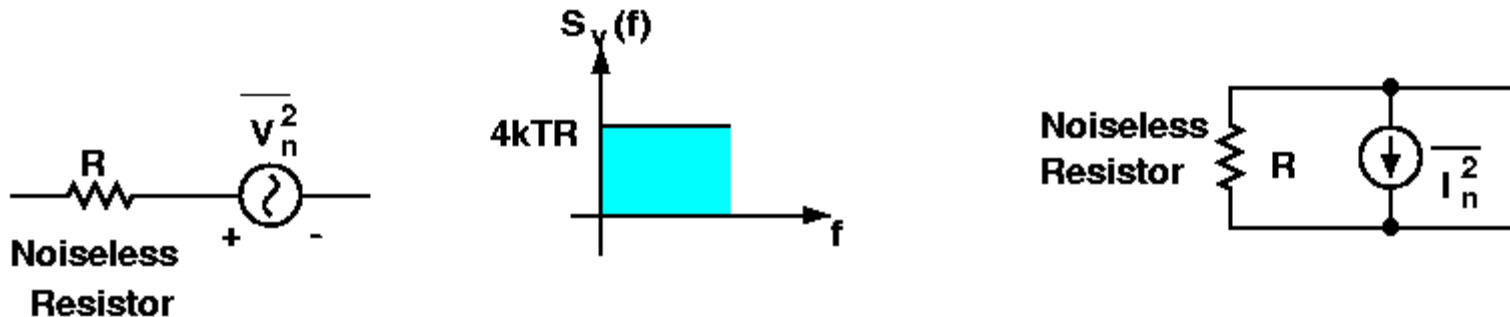
1. Statistical Characteristics of Noise
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# Types of Noise

- Device electronics
  - Thermal noise
  - Flicker noise
- Environmental noise
  - Supply
  - Ground
  - Substrate

# Thermal Noise

- Thermal noise (white noise)
  - Resistor thermal noise - the random motion of electrons in a conductor introduces fluctuations in the voltage measured across the conductor even if the average current is zero.
  - The spectrum of thermal noise is proportional to the absolute temperature.



$$S_v(f) = 4kTR \text{ (V}^2/\text{Hz)} \quad f \geq 0, \quad \overline{V_n^2} = 4kTR \times 1\text{Hz} \text{ (V}^2), \quad k = 1.38 \times 10^{-23} \text{ (J / K)} \text{ Boltzmann constant}$$

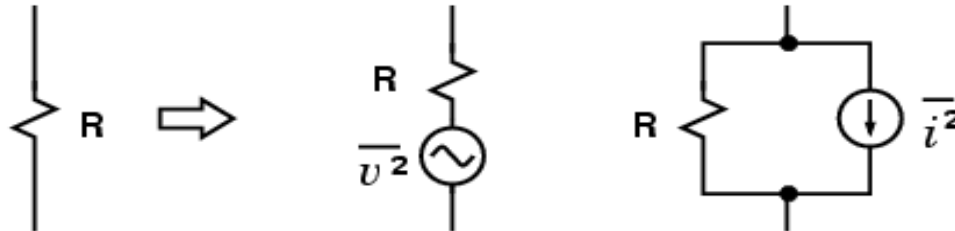
- Example : a 50  $\Omega$  resistor at  $T = 300^\circ \text{K}$  exhibits  $8.28 \times 10^{-19} \text{ V}^2/\text{Hz}$  of thermal noise, or  $0.91 \text{ nV}/\sqrt{\text{Hz}}$
- The thermal noise of a resistor can be represented by a parallel current source as well.

$$\overline{I_n^2} = 4kT / R \quad (\text{A}^2 / \text{Hz})$$

# Thermal Noise

- The thermal noise is white. In reality,  $S_v(f)$  is flat for up to roughly 100 THz, dropping at higher frequencies.
- The polarity used for the voltage source is unimportant.

## Thermal Noise



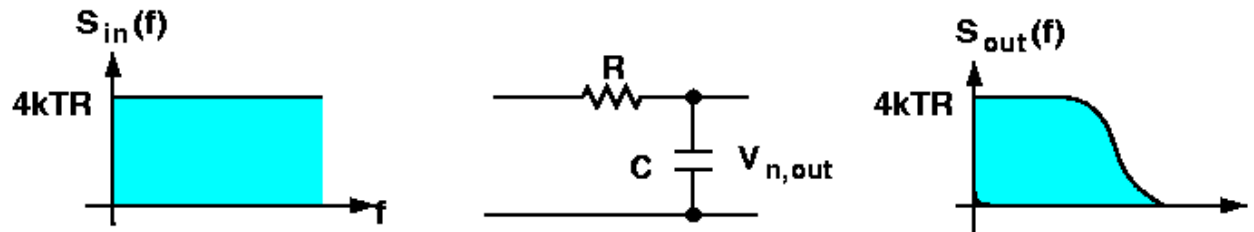
$T$  = Absolute temperature in Kelvins  
 $k$  =  $1.38 \times 10^{-23}$  watt/K-Hz (Boltzmann's constant)  
 $\Delta f$  = Bandwidth per Hertz

$$\frac{\overline{v^2}}{\Delta f} = 4kTR$$

$$\frac{\overline{i^2}}{\Delta f} = 4kT \frac{1}{R}$$

$$f = 0 - \infty$$

# Noise Spectrum Shaping : LP Filter



- Modeling the noise of  $R$  by a series voltage source  $V_R$ . The transfer function from  $V_R$  to  $V_{out}$

$$\frac{V_{out}}{V_R}(s) = \frac{1}{1 + sRC}$$

- We have

$$S_{out}(f) = S_R(f) \left| \frac{V_{out}}{V_R}(j\omega) \right|^2 = 4kTR \frac{1}{4\pi^2 R^2 C^2 f^2 + 1}$$

- The total noise power at the output

$$P_{n,out} = \int_0^\infty \frac{4kTR}{4\pi^2 R^2 C^2 f^2 + 1} df = \frac{2kT}{\pi C} \tan^{-1} u \Big|_{u=0}^{u=\infty} = \frac{kT}{C} \text{ (V}^2\text{)} \quad \text{for} \quad \int \frac{dx}{x^2 + 1} = \tan^{-1} x$$

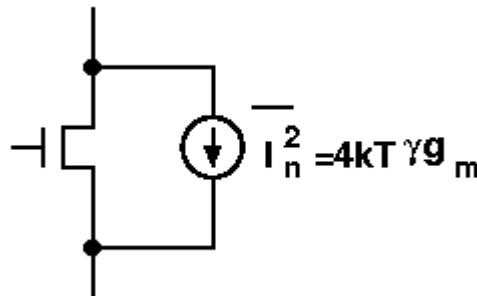
- Example : for a 1 pF capacitor, the total noise voltage is equal to  $64.3 \mu\text{V}_{\text{rms}}$ .
- The total noise at the output of the circuit is independent of the value  $R$ .
- Low temperature operation can decrease noise in analog circuits. The mobility of charge carriers in MOS devices also increase at low temperatures.

# Thermal Noise in MOSFET

- For long-channel MOS devices operating in saturation region, the channel noise can be modeled by

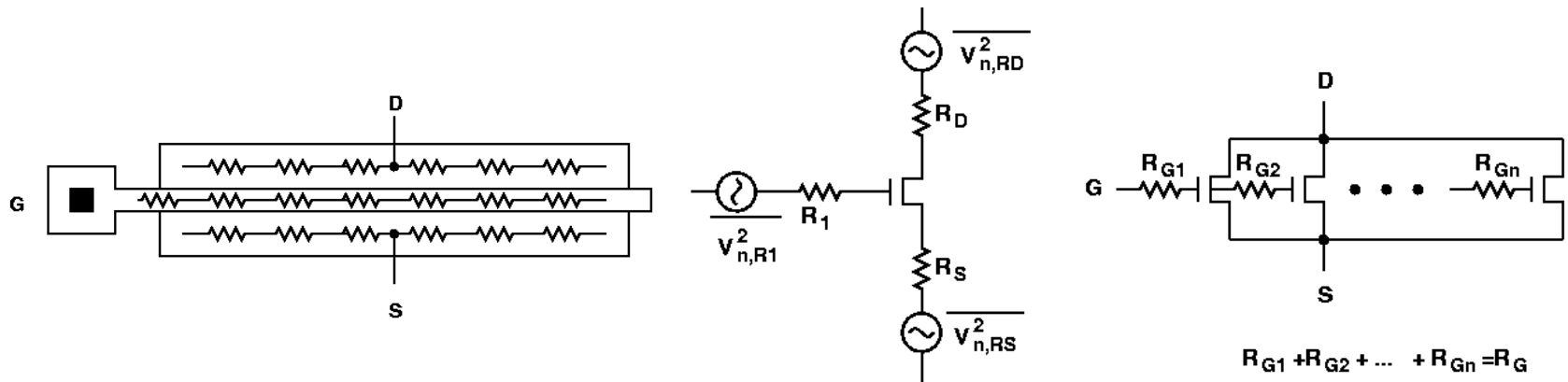
$$\overline{I_n^2} = 4kT\gamma g_m$$

- The coefficient  $\gamma$  is derived to be equal to  $2/3$  for long channel transistors and may need to be replaced by a larger value for submicron MOSFETs. (ex. 2.5 for 0.25- $\mu\text{m}$  MOS devices)

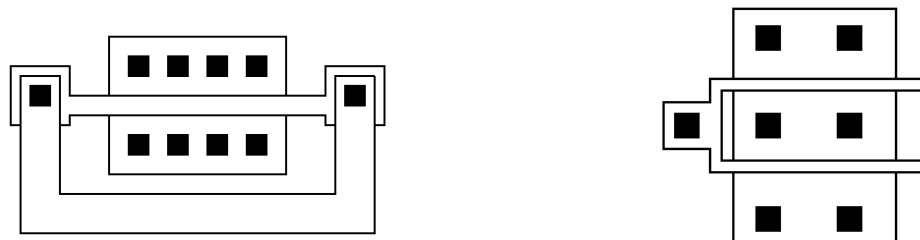


# Thermal Noise in MOSFET

- The ohmic sections of a MOSFET also contribute thermal noise.
- For a relatively wide transistor, the gate distributed resistance may become noticeable.

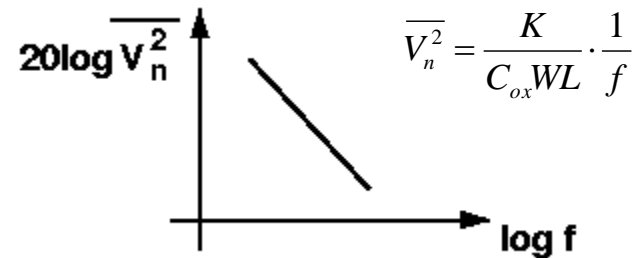
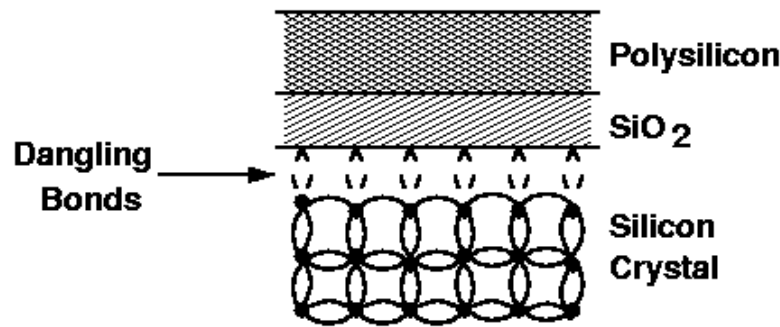


- A lumped resistor  $R_1$  represents the distributed gate resistance.  $R_1 = R_G / 3$
- Reduction of gate resistance by adding contacts to both sides or folding.



# Flicker Noise

- Since the silicon crystal reaches an end at the interface, many dangling bonds appear, give rise to extra energy states.
- As carriers move to the interface, some are randomly trapped and later released by such energy states, introducing “flicker” noise in the drain current.



- The flicker noise is modeled as a voltage source series with the gate :

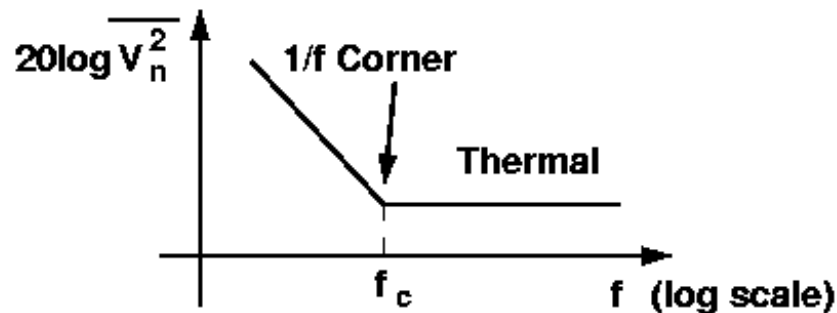
$$\overline{V_n^2} = \frac{K}{C_{ox} WL} \cdot \frac{1}{f}, \quad WL \uparrow, \quad f \uparrow, \quad \overline{V_n^2} \downarrow$$

- Where K is a process-dependent constant on the order of  $10^{-25} \text{ V}^2 \text{ F}$ .
- Our notation assumes a bandwidth of  $1 \text{ Hz}$ .
- The trap-and-release phenomenon occurs at low frequencies more often. ( $1/f$  noise)
- PMOS devices exhibits less  $1/f$  noise than NMOS.



# Flicker Noise Corner Frequency

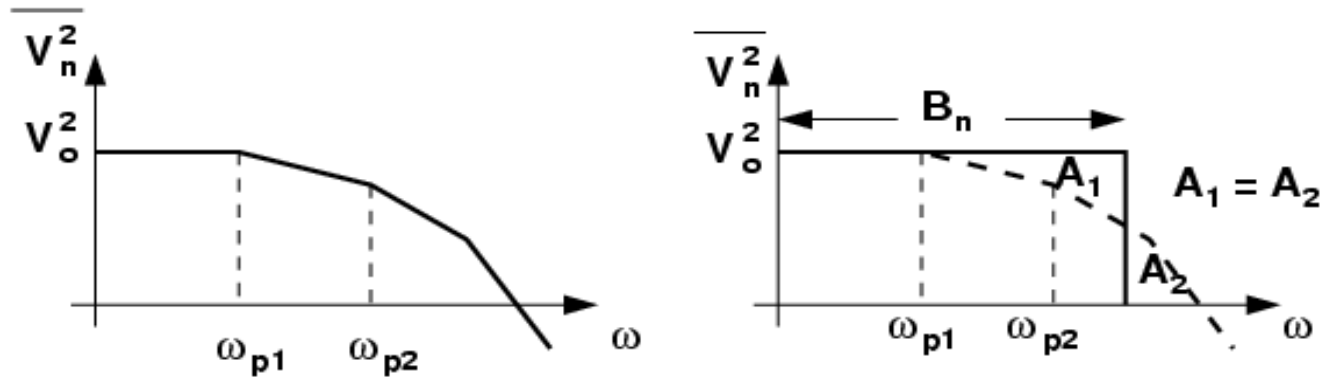
- As  $f$  approaches DC, noise becomes indistinguishable from thermal drift or aging of devices.
- Corner frequency : the intersection point serves as a measure of what part of the band is mostly corrupted by flicker noise.



$$4kT\left(\frac{2}{3}g_m\right) = \frac{K}{C_{ox}WL} \cdot \frac{1}{f_c} \cdot g_m^2$$
$$f_c = \frac{K}{C_{ox}WL} g_m \frac{3}{8kT}$$

- $f_c$  generally depends on device dimensions and bias current. However, for a given  $L$ , the dependence is relatively weak.
- The  $1/f$  noise corner is relatively constant, falling in the vicinity of  $500\text{ kHz}$  to  $1\text{ MHz}$  for submicron transistors.

# Noise Bandwidth



- Noise bandwidth  $B_n$  : allows a fair comparison of circuits that exhibit the same low-frequency noise  $V_0^2$  , but different high-frequency transfer functions.

$$\overline{V_{n,out,tot}^2} = \int_0^{\infty} \overline{V_{n,out}^2} df, \quad V_0^2 \cdot B_n = \int_0^{\infty} \overline{V_{n,out}^2} df, B_n \equiv \text{Noise Bandwidth}$$

- The total noise must be evaluated by calculating the total area under the spectral density, for a single-pole filter

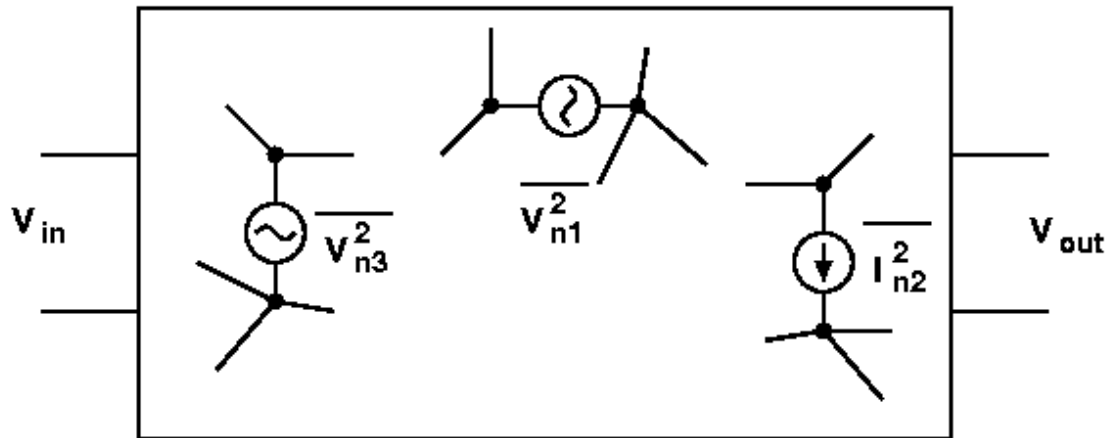
$$H(s) = (1 + s / \omega_0)^{-1}, B_n = \int_0^{\infty} |H(j2\pi f)|^2 df = \int_0^{\infty} \left[ 1 + \left( \frac{f}{f_0} \right)^2 \right]^{-1} df = \frac{\pi}{2} f_0$$

# Outline

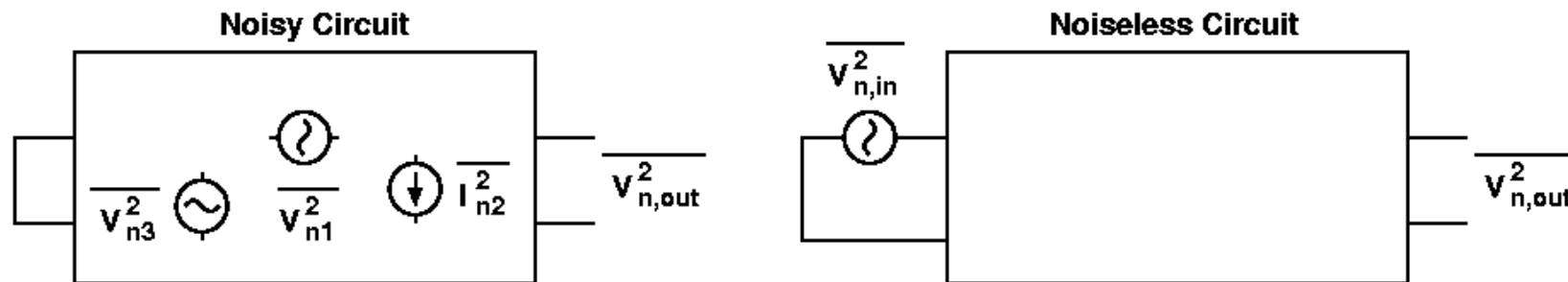
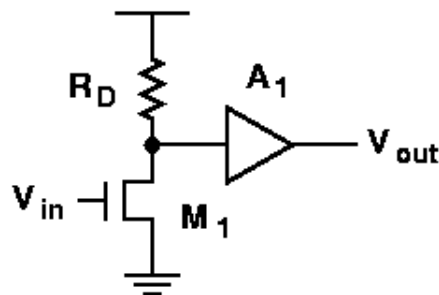
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# Representation of Noise in Circuits

- Set the input to zero and calculate the total noise at the output due to various sources of noise in the circuit.

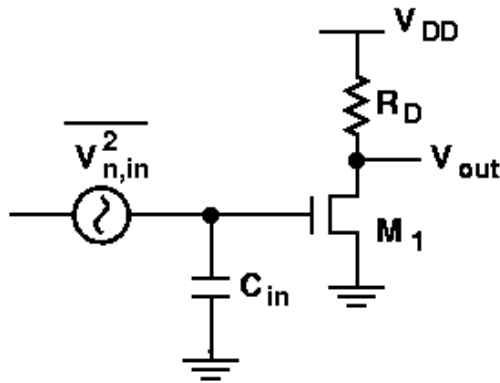


# Representation of Noise in Circuits

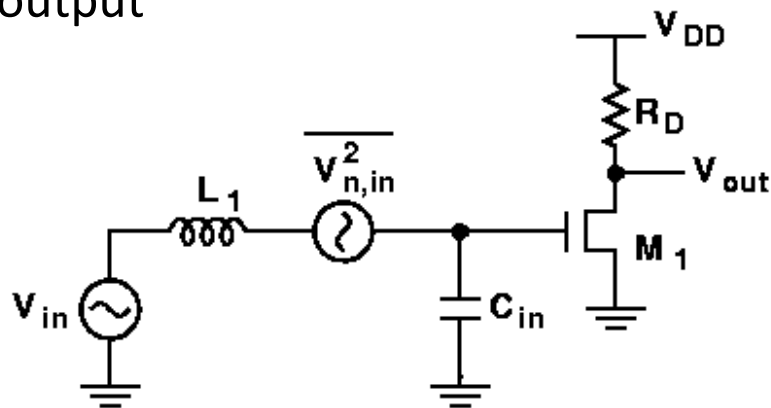


- $A_1$  amplifies the noise and signal also at the output.
- **Input referred noise** : to represent the effect of all noise sources in the circuit by a single source,  $\overline{V_{n,in}^2}$  .
  - If the voltage gain is  $A_v$ , then we must have  $\overline{V_{n,out}^2} = A_v^2 \overline{V_{n,in}^2}$
  - Indicating how much the input signal is corrupted by the circuit's noise.

# Noise Analysis of CS Gain Stage



- The preceding stage is modeled by a Thevenin equivalent with inductive output



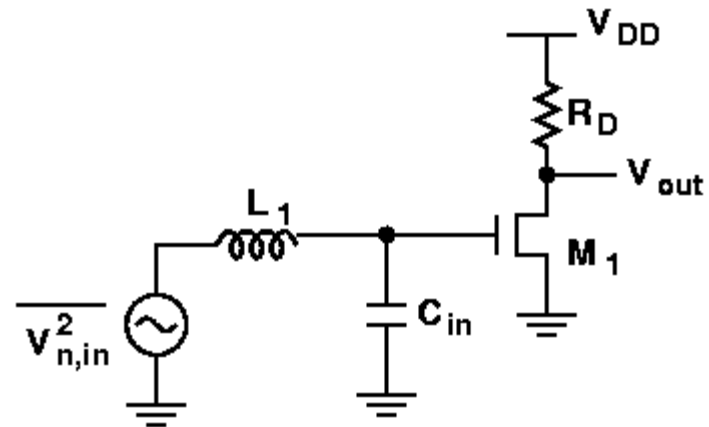
- With a finite input impedance, modeling the input referred noise by merely a voltage source, the output noise vanishes as the source impedance becomes large.

- Neglect the flicker noise

$$\overline{V_{n,out}^2} = (4kT\gamma g_m R_D^2 + 4kTR_D), \quad A_v = g_m R_D$$

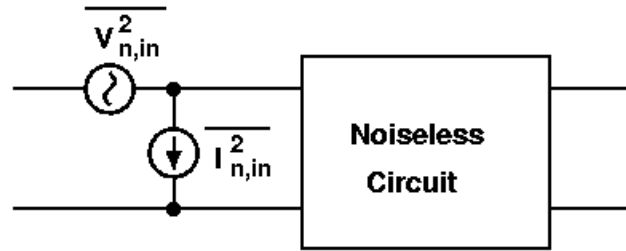
$$\overline{V_{n,in}^2} = \frac{(4kT\gamma g_m R_D^2 + 4kTR_D)}{(g_m R_D)^2} = \frac{4kT\gamma}{g_m} + \frac{4kT}{g_m^2 R_D}$$

- The effect of  $\overline{V_{n,in}^2}$  vanishes as  $L_1$  approaches infinity  $\rightarrow$  *incorrect*.

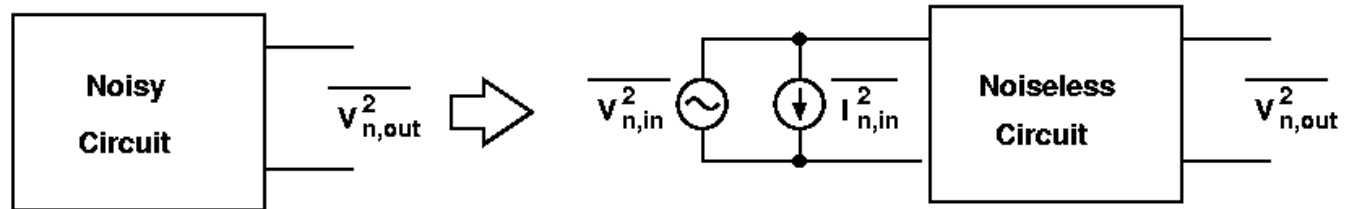


# Representation of Noise by V/I Sources

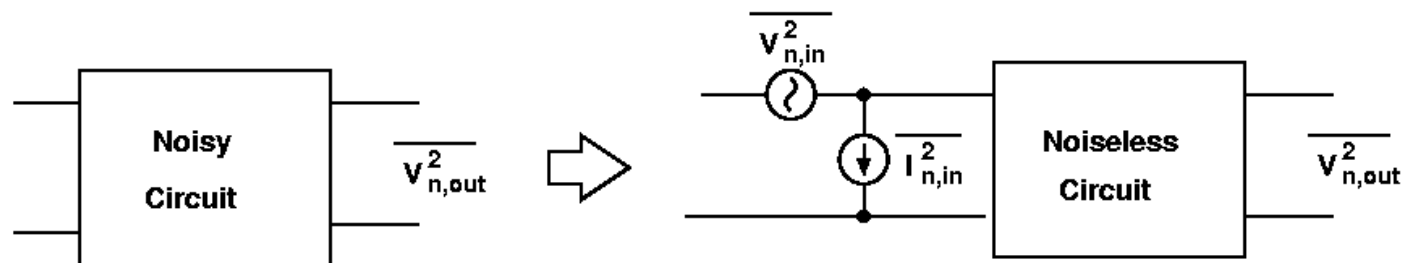
- Consider two extreme cases : zero and infinite source impedances.



- If the source impedance is zero,  $\overline{I_{n,in}^2}$  flows through  $\overline{V_{n,in}^2}$  and has no effect on the output.



- If the input is open, then  $\overline{V_{n,in}^2}$  has no effect and the  $\overline{V_{n,out}^2}$  is due to only  $\overline{I_{n,in}^2}$

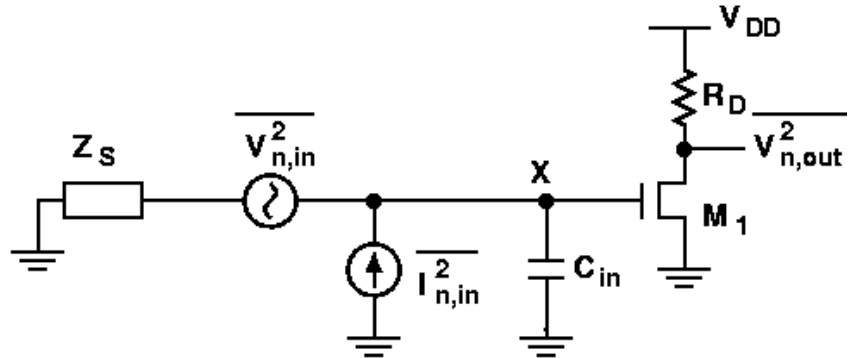


# CS Stage Simulated by a Source Imp.

- Assuming  $Z_S$  is noiseless for simplicity.

$$V_{n,in} = V_{n,M1} + \frac{1}{g_m R_D} V_{n,R_D},$$

$$I_{n,in} = sC_{in} V_{n,M1} + \frac{sC_{in}}{g_m R_D} V_{n,R_D}$$



- The two sources  $\overline{V_{n,in}^2}$  and  $\overline{I_{n,in}^2}$  are in general *correlated* simply because they may represent the same noise mechanisms in the circuit.
- $V_{n,M1}$  and  $V_{n,RD}$  appear in both  $\overline{V_{n,in}^2}$  and  $\overline{I_{n,in}^2}$
- $V_{n,X}$  is independent of  $Z_S$  and  $C_{in}$ .

$$V_{n,X} = V_{n,in} \frac{\frac{1}{sC_{in}}}{\frac{1}{sC_{in}} + Z_S} + I_{n,in} \frac{\frac{Z_S}{sC_{in}}}{\frac{1}{sC_{in}} + Z_S} = \frac{V_{n,in} + I_{n,in} Z_S}{sZ_S C_{in} + 1} = V_{n,M1} + \frac{1}{g_m R_D} V_{n,R_D}$$

$$\overline{V_{n,out}^2} = g_m^2 R_D^2 \overline{V_{n,X}^2} = 4kT \left( \frac{2}{3} g_m + \frac{1}{R_D} \right) R_D^2$$



# Outline

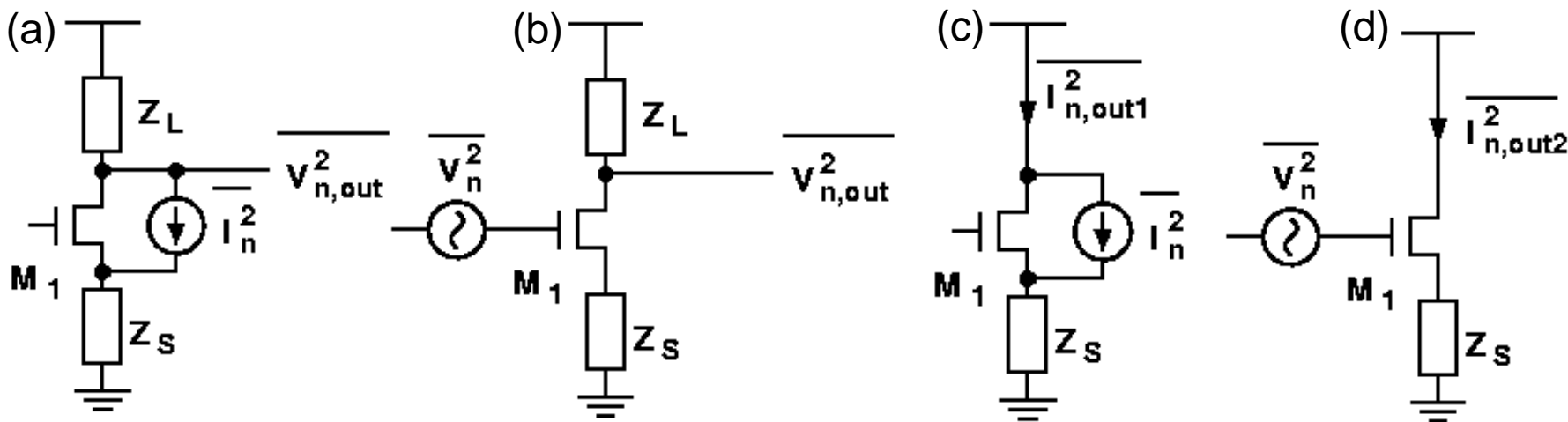
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# Noise in Single Stage Amplifier

- The circuits in (a) and (b) are equivalent at low frequencies if  $\overline{V_n^2} = \frac{I_n^2}{g_m^2}$
- Since the circuits have equal output impedance, we simply examine the output short-circuit currents

- The output noise current of the circuit (c) is  $I_{n,out1} = \frac{I_n}{Z_S (g_m + 1/r_O) + 1}$
- The output noise current of the circuit (d) is  $I_{n,out2} = \frac{g_m V_n}{Z_S (g_m + 1/r_O) + 1}$

$$I_{n,out2} = I_{n,out1}, \quad V_n = I_n / g_m$$



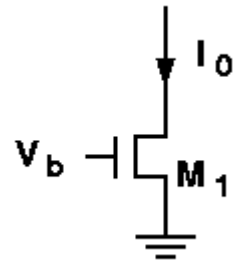
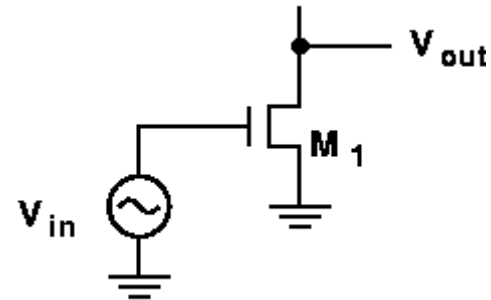
# Common Source Stage

- The input-referred noise voltage per unit bandwidth of CS

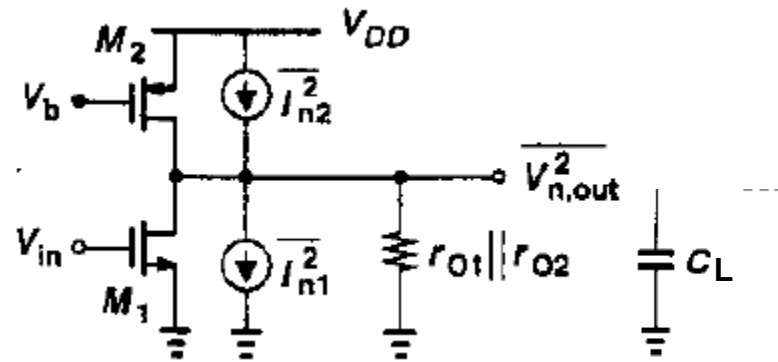
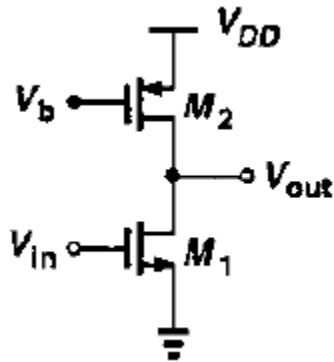
$$\overline{V_{n,in}^2} = 4kT \left( \frac{2}{3g_m} + \frac{1}{g_m^2 R_D} \right) + \frac{K}{C_{ox}WL} \frac{1}{f}$$

- To reduce the input-referred noise voltage

- The  $g_m$  of  $M_1$  must be maximized if the transistor is to amplify a voltage signal applied to its gate.
- If  $g_{m1} \uparrow \rightarrow I_D \uparrow \rightarrow$  greater power dissipation and limited voltage swings.
- If  $g_{m1} \uparrow \rightarrow W/L \uparrow \rightarrow$  larger input and output capacitance.
- The transconductance of  $M_1$  must be minimized if the transistor operates as a current source.
- Noise contributed by  $R_D$  decreases as  $R_D$  increases.
  - Limiting the voltage headroom and lowering the speed.
- The noise voltage due to  $R_D$  at the output proportional to  $(R_D)^{0.5}$
- The voltage gain of the circuit is proportional to  $R_D$ .
- Trade-off between noise, power dissipation, voltage headroom, and speed.



# SNR of CS Stage



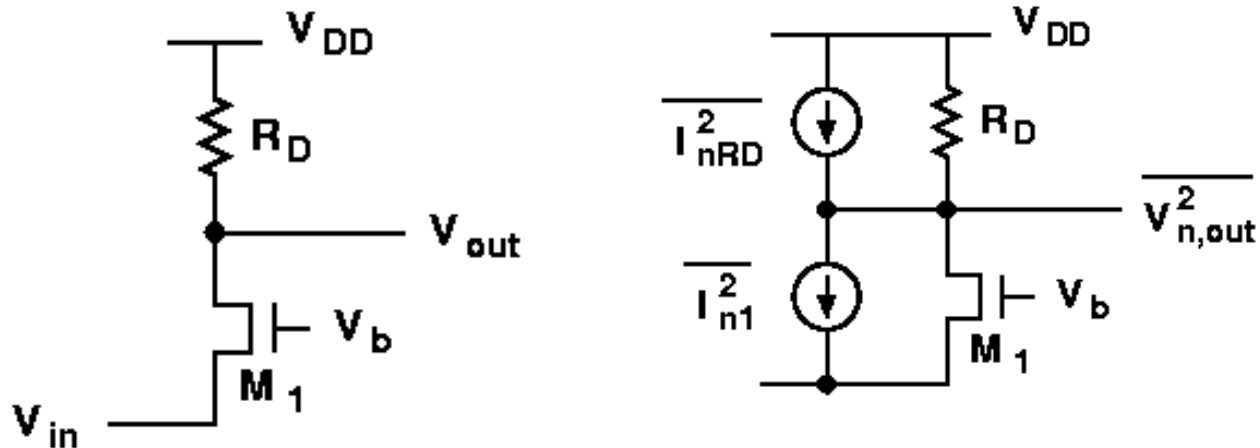
$$\overline{V_{n,out}^2} = 4kT \frac{2}{3} (g_{m1} + g_{m2})(r_{O1} \parallel r_{O2})^2 = \overline{V_{n,in}^2} (g_{m1})^2 (r_{O1} \parallel r_{O2})^2, \quad \overline{V_{n,in}^2} = 4kT \frac{2}{3} \frac{(g_{m1} + g_{m2})}{(g_{m1})^2}$$

$$\overline{V_{n,out,tot}^2} = \int_0^\infty 4kT \frac{2}{3} (g_{m1} + g_{m2})(r_{O1} \parallel r_{O2})^2 \frac{df}{1 + (r_{O1} \parallel r_{O2})^2 C_L^2 (2\pi f)^2} = \frac{2}{3} (g_{m1} + g_{m2})(r_{O1} \parallel r_{O2}) \frac{kT}{C_L}$$

$$SNR_{out} = \left[ \frac{g_{m1}(r_{O1} \parallel r_{O2})V_m}{\sqrt{2}} \right]^2 \frac{1}{(2/3)(g_{m1} + g_{m2})(r_{O1} \parallel r_{O2})(kT / C_L)} = \frac{3C_L}{4kT} \frac{g_{m1}^2 (r_{O1} \parallel r_{O2})}{g_{m1} + g_{m2}} V_m^2$$

- $C_L \uparrow$  bandwidth  $\downarrow$   $SNR \uparrow$
- $g_{m1} \uparrow$   $g_{m2} \downarrow$   $V_m \uparrow$   $SNR \uparrow$  ( $V_m$ : amplitude of sinusoid input)

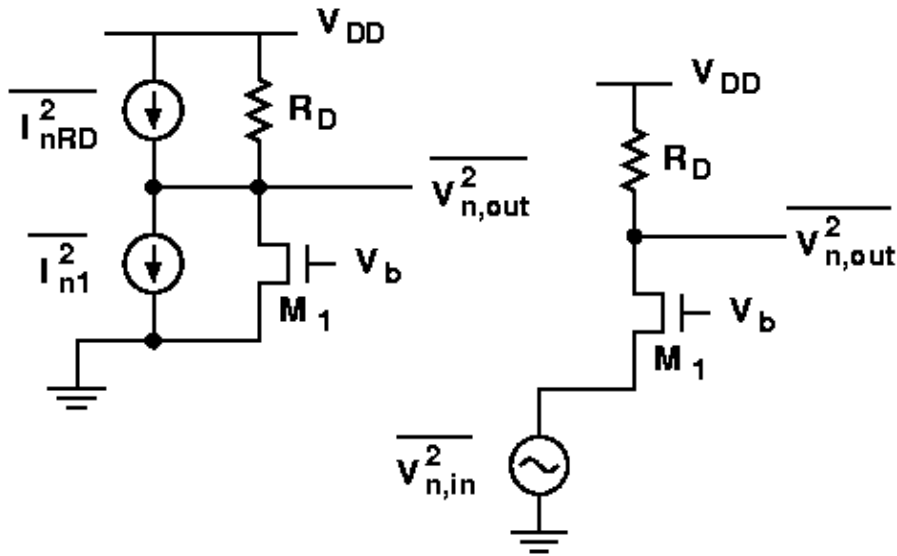
# Common-Gate Stage



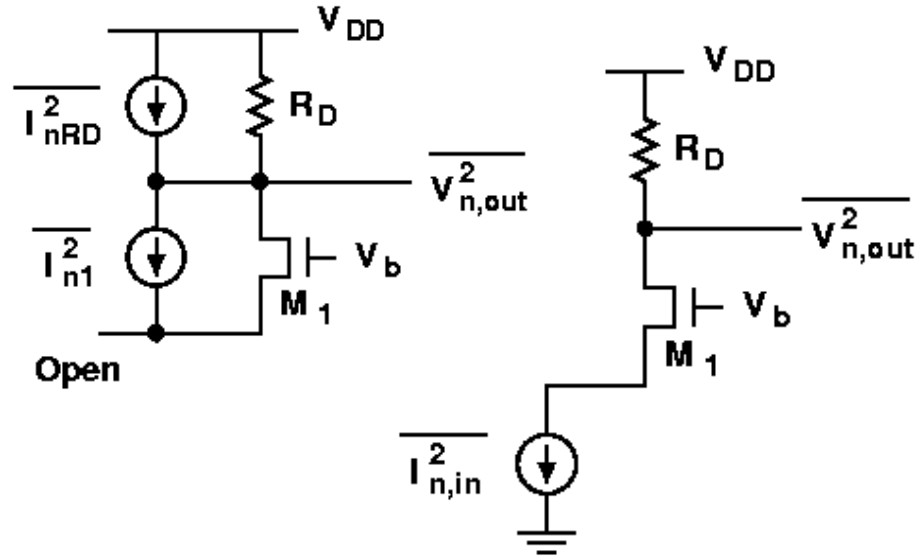
- Neglect channel length modulation effect. Represent the thermal noise of  $M_1$  and  $R_D$  by two current sources.
- Due to low input impedance of CG, the input-referred noise current is not negligible at low frequencies
- They directly refer the noise current produced by the load to the input (current-gain = 1).

# Input-referred Noise of CG

- To calculate input referred noise  $V_n$  :



- To calculate input referred noise  $I_n$  :



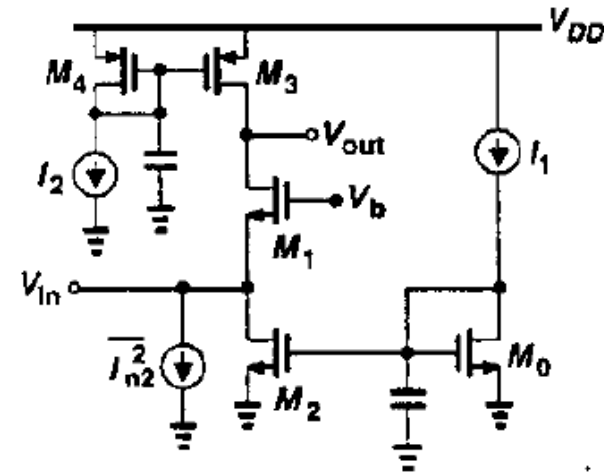
$$4kT \left( \frac{2}{3} g_m + \frac{1}{R_D} \right) R_D^2 = \overline{V_{n,in}^2} (g_m + g_{mb})^2 R_D^2, \quad \overline{V_{n,in}^2} = \frac{4kT \left( \frac{2}{3} g_m + \frac{1}{R_D} \right)}{(g_m + g_{mb})^2}$$

$$I_{n1} + I_{D1} = 0, \quad \overline{I_{n,in}^2 R_D^2} = 4kTR_D, \quad \overline{I_{n,in}^2} = \frac{4kT}{R_D}$$

- They directly refer the noise current produced by the load to the input (I-gain = 1).

# Noise Contributed by Current Source

- The drain noise current of  $M_2$  directly adds to the input referred noise current of  $\overline{I_{n2}^2}$ .
- For low noise performance,  $g_{m2} \downarrow$ ,  $g_{m2} = \frac{2I_{D2}}{(V_{GS2} - V_{TH2})}$
- For a given bias current, this requires a high voltage of  $V_b$  and limiting the voltage swing at the output node.



$$\overline{V_{n,out}^2} = 4kT \frac{2}{3} (g_{m1} + g_{m3})(r_{O1} \parallel r_{O3})^2 = \overline{V_{n,in}^2} (g_{m1} + g_{mb1})^2 (r_{O1} \parallel r_{O3})^2$$

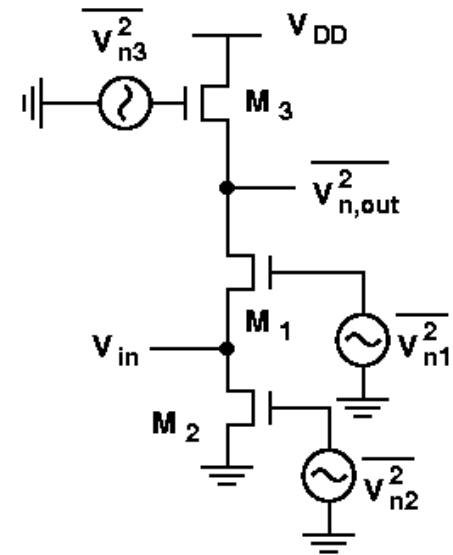
$$\overline{V_{n,in}^2} = 4kT \frac{2}{3} \frac{(g_{m1} + g_{m3})}{(g_{m1} + g_{mb1})^2} \propto g_{m3}$$

- For input-referred noise current, open the input

$$\overline{V_{n,out}^2} = (\overline{I_{n2}^2} + \overline{I_{n3}^2}) R_{out}^2 = \overline{I_{n,in}^2} R_{out}^2, \quad \overline{I_{n,in}^2} = (\overline{I_{n2}^2} + \overline{I_{n3}^2}) = 4kT \frac{2}{3} (g_{m2} + g_{m3}) \propto g_{m2}, g_{m3}$$

# Noise Contributed by 1/f Noise

- Consider Flicker noise
  - Each 1/f noise is modeled by a voltage source in series with the gate of the corresponding transistor.
- Let  $K_N$  and  $K_P$  denote the flicker noise coefficient of NMOS and PMOS devices. When the input shorted to ground, we have



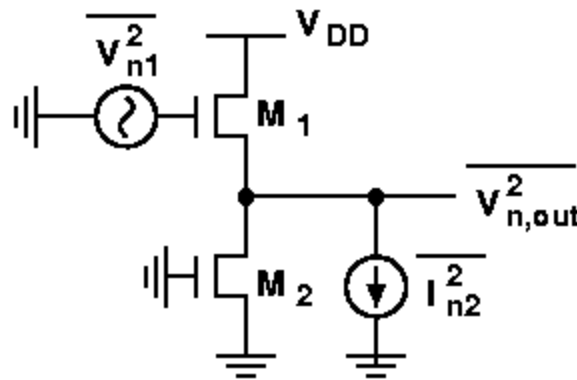
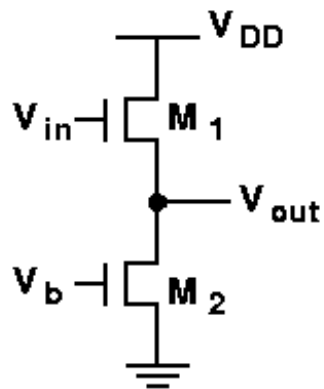
$$\overline{V_{n,out}^2} = \frac{1}{C_{ox}f} \left[ \frac{g_{m1}^2 K_N}{(WL)_1} + \frac{g_{m3}^2 K_P}{(WL)_3} \right] (r_{O1} \parallel r_{O3})^2 \quad \text{Thus} \quad \overline{V_{n,in}^2} = \frac{1}{C_{ox}f} \left[ \frac{g_{m1}^2 K_N}{(WL)_1} + \frac{g_{m3}^2 K_P}{(WL)_3} \right] \frac{1}{(g_{m1} + g_{mb1})^2}$$

- With the input open

$$\overline{V_{n,out}^2} = \frac{1}{C_{ox}f} \left[ \frac{g_{m2}^2 K_N}{(WL)_2} + \frac{g_{m3}^2 K_P}{(WL)_3} \right] R_{out}^2 \quad \text{yielding} \quad \overline{I_{n,in}^2} = \frac{1}{C_{ox}f} \left[ \frac{g_{m2}^2 K_N}{(WL)_2} + \frac{g_{m3}^2 K_P}{(WL)_3} \right]$$



# Source Followers



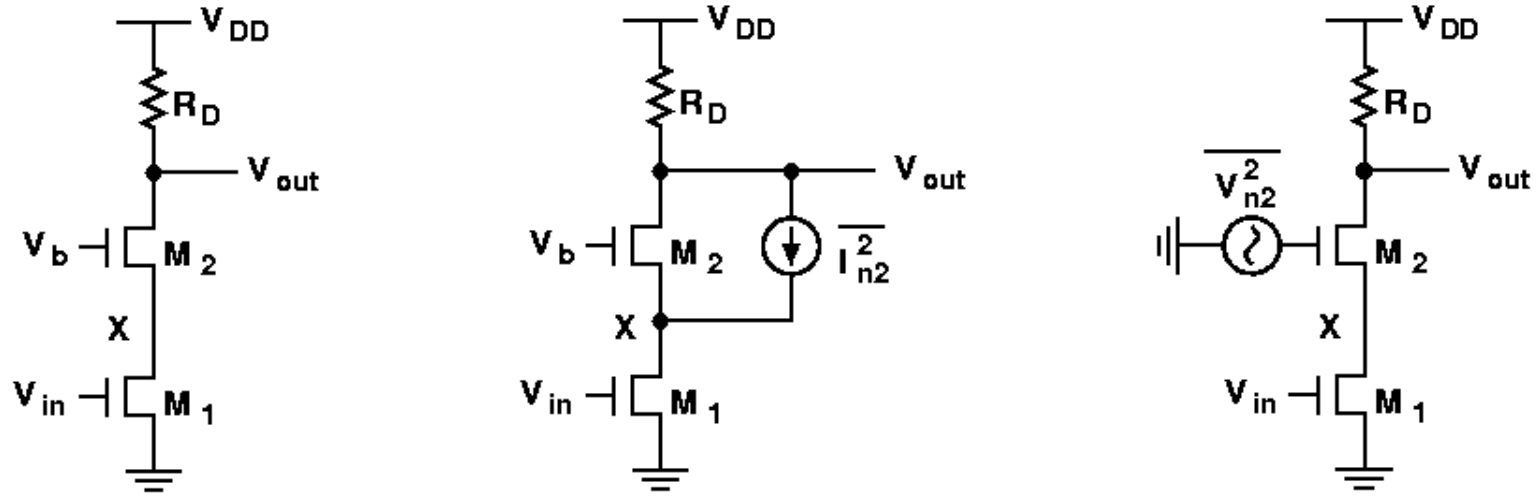
$$\overline{V_{n,in}^2} = \overline{V_{n1}^2} + \frac{\overline{V_{n,out}^2}|_{M2}}{A_v^2} = 4kT \frac{2}{3} \left( \frac{1}{g_{m1}} + \frac{g_{m2}}{g_{m1}^2} \right)$$

or  $\overline{V_{n,in}^2} = \frac{(I_{n1}^2 + I_{n2}^2) R_{out}^2}{A_v^2}, \quad \frac{R_{out}}{A_v} = \frac{1}{g_{m1}}$

$$R_{out} = \left( \frac{1}{g_{m1}} \parallel R_o \right), \quad A_v = \frac{R_o}{R_o + 1/g_{m1}}$$

- $M_2$  serves as the bias current source .
- Since the input impedance of the circuit is quite high, even at relatively high frequencies, the input-referred noise current can usually be neglected for moderate driving source impedances.
- Since source followers add noise to the input signal while providing a voltage gain less than unity, **they are usually avoided in low-noise amplification.**

# Cascode Stage



- Consider the noise current of  $M_1$  and  $R_D$ . At low frequencies, the noise currents of  $M_1$  and  $R_D$  flow through  $R_D$

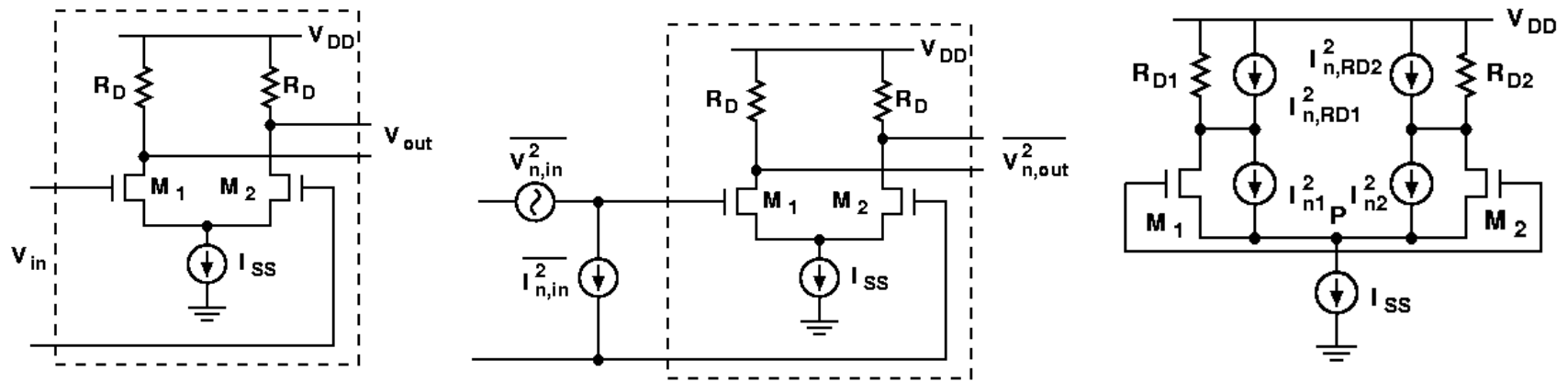
$$\overline{V_{n,in}^2} \Big|_{M1, RD} = 4kT \left( \frac{2}{3g_{m1}} + \frac{1}{g_{m1}^2 R_D} \right)$$

- Consider the noise current of  $M_2$ , (*CS + Source degeneration*)

$$\frac{V_{n,out}}{V_{n2}} \approx \frac{-R_D}{1/sC_X + 1/g_{m2}}$$

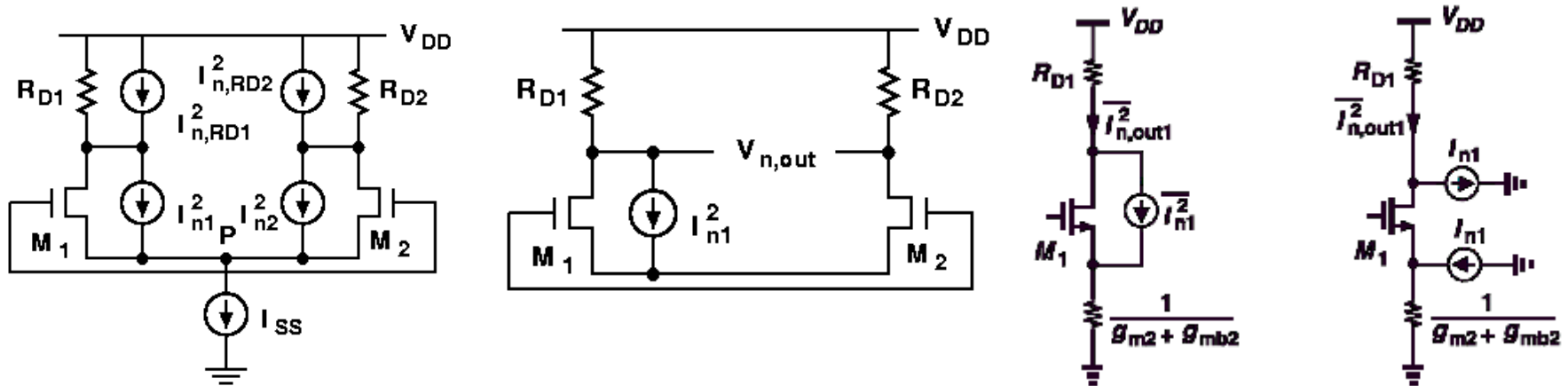
- The input referred noise of a cascode stage may rise considerably at high freq.

# Noise in Differential Pairs



- For low frequency operation, the magnitude of  $\overline{I_{n,in}^2}$  is typically negligible.
- To calculate the thermal component of  $\overline{V_{n,in}^2}$ , short input
  - Since  $\overline{I_{n1}^2}$  and  $\overline{I_{n2}^2}$  are uncorrelated, node  $P$  can not be considered a virtual ground.

# Input Referred Noise of DP



- Decomposing  $I_{n1}$  into two (correlated) current sources and calculating their effect at the output.

$$V_{n,out}|_{M1} = \frac{I_{n1}}{2} R_{D1} + \frac{I_{n1}}{2} R_{D2}$$

- If  $R_{D1} = R_{D2} = R_D$   $\overline{V_{n,out}^2}|_{M1} = \overline{I_{n1}^2} R_D^2$ ,  $\overline{V_{n,out}^2}|_{M2} = \overline{I_{n2}^2} R_D^2$ ,  $\overline{V_{n,out}^2}|_{M1,M2} = (\overline{I_{n1}^2} + \overline{I_{n2}^2}) R_D^2$

- Taking into account the noise of  $R_{D1} = R_{D2}$

$$\overline{V_{n,out}^2} = (\overline{I_{n1}^2} R_D^2 + \overline{I_{n2}^2} R_D^2) + 2(4kTR_D) = 8kT \left( \frac{2}{3} g_m R_D^2 + R_D \right)$$

$$\overline{V_{n,in}^2} (CS) = 4kT \left( \frac{2}{3g_m} + \frac{1}{g_m^2 R_D} \right)$$

- Dividing the result by the square of the differential gain:  $\overline{V_{n,in}^2} = 8kT \left( \frac{2}{3g_m} + \frac{1}{g_m^2 R_D} \right)$

# Input-Referred Noise of DP

- Placing the voltage sources given by  $K/(C_{ox}WL)$  in series with each gate

$$\overline{V_{n,in}^2} = 8kT \left( \frac{2}{3g_m} + \frac{1}{g_m^2 R_D} \right) + \frac{2K}{C_{ox}WL} \frac{1}{f}$$

- The noise of tail current modulates the transconductance of each device

$$\Delta I_{D1} - \Delta I_{D2} = g_m \Delta V_{in} = \sqrt{2\mu_n C_{ox} \frac{W}{L} \left( \frac{I_{SS} + I_n}{2} \right)} \Delta V_{in}$$

- In essence, the noise modulates the transconductance of each device

$$\Delta I_{D1} - \Delta I_{D2} \approx \sqrt{2\mu_n C_{ox} \frac{W}{L} \cdot \frac{I_{SS}}{2} \left( 1 + \frac{I_n}{2I_{SS}} \right)} \Delta V_{in} = g_{m0} \left( 1 + \frac{I_n}{2I_{SS}} \right) \Delta V_{in}$$

$g_{m0} : g_m$  of noiseless circuit

- The effect is nonetheless usually negligible.

$$\overline{V_{n,in}^2}(CS) = 4kT \left( \frac{2}{3g_m} + \frac{1}{g_m^2 R_D} \right) + \frac{K}{C_{ox}WL} \frac{1}{f}$$

